





Output Over Voltage Protection

The output voltage is monitored by an OVP circuitry. If the output voltage or the voltage apply from external of the converter rises to a fault condition (pre-setting value), which could be damaging to the load circuitry, then OVP circuitry will shut down the unit until the Input Voltage or Enable Input was recycled.

Apply an external voltage to the Synchronous-Rectifier models may cause permanent damages on the module.

OVP set point is 10% higher than maximum output voltage.

Single output:

The converters will shut down if Vout > Vout nominal +20%. Because the single output converters have a trim function that allows users to adjust the output voltage ±5% or ±10%; hence, the Output Over Voltage Protection is setting > 20%, to avoid trim voltage influences OVP.

Output Voltage (typ.)	5.0V	12V	15V	24V	28V	48V
OVP Trip Value	6V	14.4V	18V	28.8V	33.6	57.6

Trimming Output Voltage - for Single output models

Only the single output converters have a trim function that allows users to adjust the output voltage ±10% for non-Brick and ±5% for Brick, please refer to the trim table in every datasheet for details. Adjustments to the output voltage can be used with a simple fixed resistor as shown in Figures 3 and 4. A single fixed resistor can increase or decrease the output voltage depending on its connection. Resistors should be located close to the converter.

* If the trim function is not used, leave the trim pin open.

Trim adjustments higher than the specified range can have an adverse effect on the converter's performance and are not recommended.

Excessive voltage differences between output voltage and sense voltage, in conjunction with trim adjustment of the output voltage; can cause the OVP circuitry to activate.

Thermal de-rating is based on maximum output current and voltage at the converter's output pins. Use of the trim and sense functions can cause output voltages to increase, thereby increasing output power beyond the converter's specified rating. Therefore: $(V_{OUT} \text{ at pins}) X (I_{OUT}) \leq \text{rated output power}$

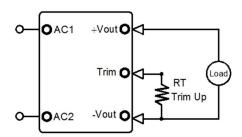


Figure 3. Trim Connections To Output Voltages adjustment For Non Brick Series

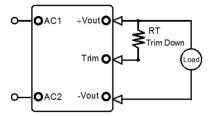


Figure 4. Trim Connections To Output Voltages adjustment For Brick Series

Remote Sense

Except for non-Brick series converters, all brick series converters employ the remote sense feature to provide point of use regulation, thereby overcoming moderate IR drops in pcb conductors or cabling. The Sense and VOUT lines are internally connected through low value resistors. Nevertheless, if the sense function is not used for remote regulation, the user should connect the +Sense to +VOUT and -Sense to -VOUT at the AC-DC converter pins as shown in Figure 5(a) below.

The remote sense lines carry very little current and therefore require minimal cross-sectional-area conductors. The sense lines are used by the feedback control-loop to regulate the output. As such, they are not low impedance points and must be treated with care in layouts and cabling. Sense lines on a pcb should be run adjacent to dc signals, preferably ground. In cables and discrete wiring applications, twisted pair or other techniques should be implemented as shown in Figure 5(b) below.

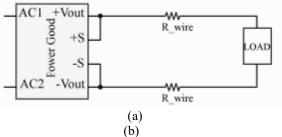
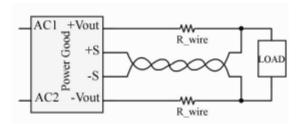


Figure 5. Remote Sense Circuit Configuration

All brick series converters will compensate for drops between the output voltage and the sense voltage at the AC-DC provided that:

 $[Vout(+) - Vout(-)] - [Sense(+) - Sense(-)] \le 5\% Vout$



Application Notes

Minimax Output Load Requirement

All AC/DC converters regulate within spec and are stable under no-load to full load conditions. Operation under no-load conditions however might slightly increase the output ripple and noise.

Floating Outputs

Since these are isolated AC/DC converters, their outputs are "floating" with respect to their input. Designers will normally use the -Vout as the ground/return of the load circuit. You can, however, use the +Vout as ground return to effectively reverse the output polarity.

EMI Consideration

ACE25/60 AC/DC converters can meet Class B in EN 55032, CISP 22 and FCC part 15J without external Filter. Except for ACE25/60 series, the conducted EMI measurement is recommended to use a simple extra circuit at input of AC/DC converters to meet the standard. For further details, please contact us.

Connection in Parallel

In general, there are two types of the parallel methods, one is active and the other is passive.

(1) Active current share

Only ACF700 series provide one kind active current share function for parallel. Please refer to the datasheets for further information.

(2) Passive current share

A simple method of parallel connection is the use of an oring diode on each unit. See figure 8. By adjusting the outputs with Potentiometers, it is possible to achieve the current sharing of the units. The voltage rating of the external diodes must be greater than Vout. The current rating of external diodes should be greater than 2 times of each output.

The strength is that it's oring diode will become reversed biased and reduce the failure rate from affecting the bus voltage. This is the essential feature in a redundant power configuration. The weakness is the power loss in the diodes and dissipating the heat generated in the diodes. The loss is significant and should always be considered.

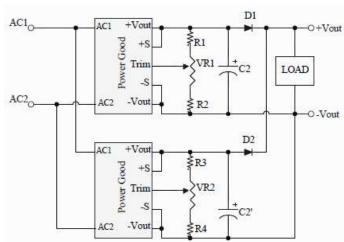


Figure 8. Connection in Parallel

Redundancy

As stated above, AC-DC Converters' connection in parallel is used to reduce the failure rate and further to improve the reliability of the system. An important thing is that it's not desirable to lift power. Because the output voltage of the AC-DC converters can't be completely equal, the converter with higher output voltage may provide full load current. It does not matter but make sure that the output current from each power supply does not exceed the rate current. See Figure 9.

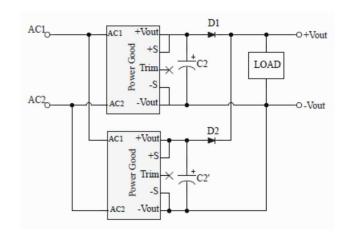


Figure 9. Redundant Connect

Soldering Operation Recommendations

Note1:The IPC-A-610 standard requires that solder fill at least 75% of the barrel to ensure a solid connection. Ideally, all connections should have a 100% fill.

Note2:Hand-Soldering Guideline for Multi-layers PCB board 400°C+/-10 °C temperature on a 70W iron

(ø1mm) 400°C Soldering time <6S (ø2mm) 400°C Soldering time <4S

Note3:Reflow soldering is not a suggested method for through-hole power modules due to many process and reliability concerns. If you have this kind of application requirement, please contact Power Good sales or FAE for further confirmation.